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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
10/711,185	08/31/2004	William E. Bernier	FIS920040056US1	5184
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FREDERICK W. GIBB, III GIBB INTELLECTUAL PROPERTY LAW FIRM, LLC 2568-A RIVA ROAD SUITE 304 ANNAPOLIS, MD 21401			IM, JUNGHWA M	
			ART UNIT	PAPER NUMBER
			2811	
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Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)
	10/711,185	BERNIER ET AL.
Office Action Summary	Examiner	Art Unit
	Junghwa M. Im	2811
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the c	orrespondence address
A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DA - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication If NO period for reply is specified above, the maximum statutory period w - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tirr fill apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE	I. lely filed the mailing date of this communication. D (35 U.S.C. § 133).
Status		
1) Responsive to communication(s) filed on 10 At 2a) This action is FINAL. 2b) This 3) Since this application is in condition for allowar closed in accordance with the practice under E	action is non-final. nce except for formal matters, pro	
Disposition of Claims		
4) Claim(s) 8-25 is/are pending in the application. 4a) Of the above claim(s) is/are withdray 5) Claim(s) 20-25 is/are allowed. 6) Claim(s) 8-20 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/or are subject to restriction and/or are subject to by the Examine. 10) The specification is objected to by the Examine. 10) The drawing(s) filed on is/are: a) access that any objection to the or Replacement drawing sheet(s) including the correction. 11) The oath or declaration is objected to by the Examine.	vn from consideration. r election requirement. r. epted or b) □ objected to by the beginning(s) be held in abeyance. See ion is required if the drawing(s) is objected to by the beginning(s) is objected to be a beginning(s) is objected to be a beginning(s).	e 37 CFR 1.85(a). ected to. See 37 CFR 1.121(d).
Priority under 35 U.S.C. § 119		
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the prior application from the International Bureau * See the attached detailed Office action for a list of	s have been received. s have been received in Applicati ity documents have been receive (PCT Rule 17.2(a)).	on No ed in this National Stage
Attachment(s) Notice of References Cited (PTO-892) Notice of Draftsperson's Patent Drawing Review (PTO-948) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal P 6) Other:	

DETAILED ACTION

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claim Rejections - 35 USC § 103

Claims 8-14 are rejected under 35 U.S.C. 103(a) as being unpatentable over Benenati et al. (US 6177729), hereinafter Benenati in view of Oh et al. (US 6959856), hereinafter Oh.

Regarding claim 8, Fig. 1 of Benenati shows a conductive interconnection [20] for joining an integrated circuit device [26] to a device carrier [28], said conductive interconnection comprising:

a polymer having a spherical shape (col. 3, lines 48-51) between said integrated circuit device and said device carrier.

Fig. 1 of Benenati shows most aspects of the instant invention except "metal projections extending towards said polymer from at least one of said integrated circuit device and said device carrier, wherein said metal projections each have a same height and extend partially into said polymer across the width of said polymer." Fig. 4a of Oh shows a solder bump wherein metal projections [411] extending towards the bump [405] from at least one of said integrated circuit device [401] and said device carrier, wherein said metal projections each have a same height and extend partially into said bump across the width of said bump.

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It would have been obvious to one of ordinary skill in the art at the time of the invention was made to incorporate the teachings of Oh in to the device of Benenati in order to have metal projections extending towards said polymer from at least one of said integrated circuit device and said device carrier, wherein said metal projections each have a same height and extend partially into said polymer across the width of said polymer to alleviate the cracking of the solder ball.

Regarding claims 9-10, Oh discloses that the shape of the projection can be varied (col. 4, lines 15-18).

Furthermore, it would have been obvious to have the recited shapes of the projection to accommodate the cracking propagation of the solder ball since such a modification would have involved a mere change in the shape of a component. A change in shape is generally recognized as being within the level of ordinary skill in the art. *In re Dailey*, 357 F.2d 669, 149 USPQ 47 (CCPA 1966).

Regarding claim 11, Oh discloses that the projection can be continuous, therefore the combined teachings of Benenati and Oh would show that said projections extend from both said integrated device and said device carrier.

Regarding claim 12, Benenati discloses that said polymer includes metal particles (col. 3, lines 60-63).

Regarding claims 13-14, Benenati discloses that said polymer comprises epoxy or ECA electrically conductive adhesive (col. 6, lines 15-18).

Claims 15-20 are rejected under 35 U.S.C. 103(a) as being unpatentable over Benenati in view of Oh and Campbell et al. (US 6323432), hereinafter Campbell.

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Regarding claims 15-16, Fig. 1 of Benenati shows a conductive interconnection for joining an integrated circuit device [28] to a device carrier [26], said conductive interconnection comprising

a polymer having a spherical (col. 3, lines 48-51) between said integrated circuit device said device carrier.

Fig. 1 of Benenati shows most aspects of the instant invention except dendrites within said polymer, wherein dendrites comprise a palladium-plated coating on a conductive material.

Fig. 7a of Oh shows dendrites [711] within a solder bump

It would have been obvious to one of ordinary skill in the art at the time of the invention was made to incorporate the teachings of Oh in to the device of Benenati in order to have to dendrites within said polymer to improve the connection of the solder balls.

The combined teachings of Benenati and Oh fail to show that dendrites comprise a plated coating on a conductive material. Champbell discloses that dendrites comprise a palladium plating on a conductive material (col. 2, line 66 – col. 3, line 5).

It would have been obvious to one of ordinary skill in the art at the time of the invention was made to incorporate the teachings of Campbell in to the device of Benenati and Oh in order to have to dendrites plated withpalladium on a conductive material to improve the conductivity of the solder ball.

Regarding claim 17, Oh discloses that the shape of the projection is irregular (col. 4, lines 15-18).

Regarding claim 18, Benenati discloses that said polymer includes metal particles (col. 3, lines 60-63).

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Regarding claims 19-20, Benenati discloses that said polymer comprises epoxy or ECA electrically conductive adhesive (col. 6, lines 15-18).

Allowable Subject Matter

Claims 21-25 are allowed.

Response to Arguments

Applicant's arguments with respect to pending claims have been considered but are moot in view of the new ground(s) of rejection.

Conclusion

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

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Any inquiry concerning this communication or earlier communications from the examiner should be directed to Junghwa M. Im whose telephone number is (571) 272-1655. The examiner can normally be reached on MON.-FRI. 8:30AM-5:00PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Eddie C. Lee can be reached on (571) 272-1732. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

jmi

EDDIE LEE

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